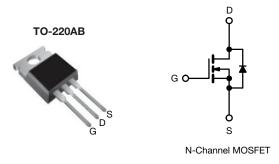
SiHP12N50E

Vishay Siliconix



E Series Power MOSFET



PRODUCT SUMMARY				
V _{DS} (V) at T _J max.	550			
R _{DS(on)} max. at 25 °C (Ω)	$V_{GS} = 10 V$	0.380		
Q _g max. (nC)	50			
Q _{gs} (nC)	6			
Q _{gd} (nC)	10			
Configuration	Single			

FEATURES

- Low figure-of-merit (FOM) Ron x Qg
- Low input capacitance (Ciss)
- · Reduced switching and conduction losses
- Low gate charge (Qg)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Computing
 - PC silver box / ATX power supplies
- Lighting

SiHP12N50E-GE3

- Two stage LED lighting
- Consumer electronics
- · Applications using hard switched topologies
 - Power factor correction (PFC)
 - Two switch forward converter
 - Flyback converter
- Switch mode power supplies (SMPS)

ORDERING INFORMATION	
Package	TO-220AB
Lood (Db) free and belegen free	SiHP12N50E-BE3 ^a
Lead (Pb)-free and halogen-free	

Note

a. "-BE3" denotes alternate manufacturing location

ABSOLUTE MAXIMUM RATINGS (T C	= 25 °C, unl	less otherwis	se noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V _{DS}	500	V	
Gate-source voltage			V _{GS}	± 30	V	
Continuous ducin suurent (T 150 °C)	V _{GS} at 10 V	$T_{\rm C} = 25 \ ^{\circ}{\rm C}$ $T_{\rm C} = 100 \ ^{\circ}{\rm C}$	- I _D	10.5		
Continuous drain current ($T_J = 150 \ ^{\circ}C$)	VGS at TO V	T _C = 100 °C		6.6	A	
Pulsed drain current ^a			I _{DM}	I _{DM} 21		
Linear derating factor				0.91	W/°C	
Single pulse avalanche energy ^b			E _{AS}	103	mJ	
Maximum power dissipation			PD	114	W	
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C	
Drain-source voltage slope $T_J = 125 \text{ °C}$		-l) / / -l+	70			
Reverse diode dV/dt ^d			dV/dt	27	V/ns	
Soldering recommendations (peak temperature) ^c	For	10 s		300	°C	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b. V_{DD} = 50 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 $\Omega,\,I_{AS}$ = 2.7 A

c. 1.6 mm from case

d. $I_{SD} \leq I_D, \, dl/dt$ = 100 A/µs, starting T_J = 25 $^\circ C$

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COMPLIANT

HALOGEN

FREE



PARAMETER	SYMBOL	TYP.		MAX.		UNIT		
Maximum junction-to-ambient	R _{thJA}	- 62 - 1.1				00.00		
Maximum junction-to-case (drain)	R _{thJC}					°C/W	°C/W	
	•		L					
SPECIFICATIONS (T _J = 25 °C, u	inless otherwi	ise noted)						
PARAMETER	SYMBOL			ONS	MIN.	TYP.	MAX.	UNI
Static	OTHEOL	120	TOONDIN				ini/ux.	
Drain-source breakdown voltage	V _{DS}	Vec =	= 0 V, I _D = 2	50 uA	500	- 1	-	V
V _{DS} temperature coefficient	ΔV _{DS} /T _J	20	e to 25 °C,		-	0.60	-	V/°(
Gate-source threshold Voltage (N)	V _{GS(th)}		$V_{GS}, I_D = 2$		2.0	-	4.0	V
	• GS(III)	-	$V_{GS} = \pm 20$		-	_	± 100	nA
Gate-source leakage	I _{GSS}		$V_{\rm GS} = \pm 20$ $V_{\rm GS} = \pm 30$		-	_	± 1	μA
			500 V, V _{GS}		_	_	1	μΑ
Zero gate voltage drain current	I _{DSS}			, T _J = 125 °C	_	_	10	
Drain-source on-state resistance	R _{DS(on)}	$V_{GS} = 10 V$		p = 6 A	-	0.330	0.380	Ω
Forward transconductance	9fs		= 30 V, I _D =		_	3.1	-	S
Dynamic	315		ee 1, D	•	<u> </u>		ļ	<u> </u>
Input capacitance	C _{iss}	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ f = 1 MHz			886	-	pF	
Output capacitance	C _{oss}			_	52	-		
Reverse transfer capacitance	C _{rss}			-	6	-		
Effective output capacitance, energy related ^a	C _{o(er)}	- V _{DS} = 0 V to 400 V, V _{GS} = 0 V		-	45	-		
Effective output capacitance, time related ^b	C _{o(tr)}			-	131	-		
Total gate charge	Qg				-	25	50	1
Gate-source charge	Q _{gs}	V _{GS} = 10 V I _D = 6 A, V _{DS} = 400 V		-	6	-	nC	
Gate-drain charge	Q _{gd}				-	10	-	1
Turn-on delay time	t _{d(on)}	$V_{DD} = 400 \text{ V}, \text{ I}_{D} = 6 \text{ A},$ $V_{GS} = 10 \text{ V}, \text{ R}_{g} = 9.1 \Omega$		-	13	26		
Rise time	t _r			-	16	32	1	
Turn-off delay time	t _{d(off)}			-	29	58	- ns	
Fall time	t _f			-	12	24		
Gate input resistance	Rg	f = 1 MHz, open drain		-	0.92	-	Ω	
Drain-Source Body Diode Characteristic	s	<u>.</u>						
Continuous source-drain diode current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	10.5	A	
Pulsed diode forward current	I _{SM}			-	-	21		
Diode forward voltage	V _{SD}	T _J = 25 °C	, I _S = 7.5 A	, V _{GS} = 0 V	-	-	1.2	V
Reverse recovery time	t _{rr}				-	244	-	ns
Reverse recovery charge	Q _{rr}		5 °C, I _F = I _S 100 A/us_V		-	2.5	-	μΟ
Reverse recovery current	I _{RRM}	dl/dt = 100 A/µs, V _R = 25 V		-	19	-	A	

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

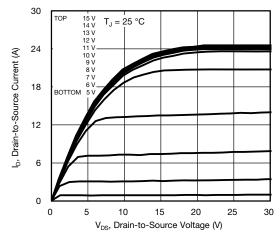


Fig. 1 - Typical Output Characteristics

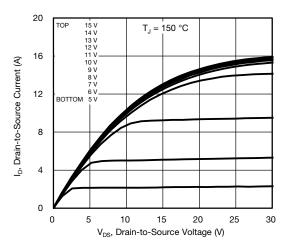


Fig. 2 - Typical Output Characteristics

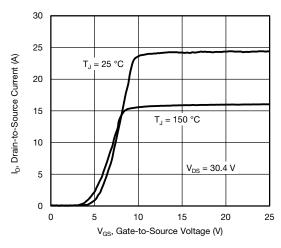


Fig. 3 - Typical Transfer Characteristics

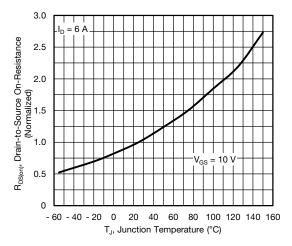


Fig. 4 - Normalized On-Resistance vs. Temperature

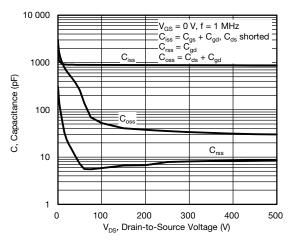


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

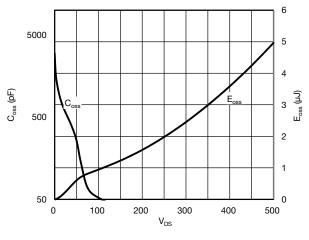


Fig. 6 - C_{oss} and E_{oss} vs. V_{DS}

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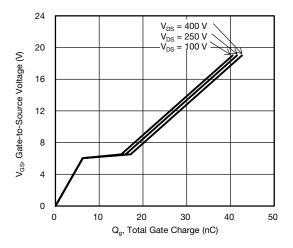


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

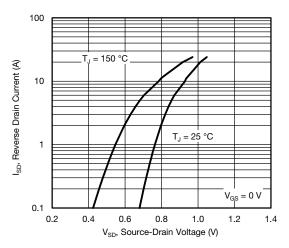


Fig. 8 - Typical Source-Drain Diode Forward Voltage

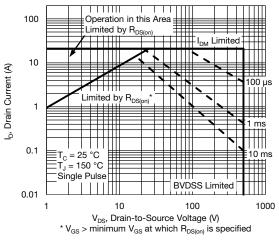


Fig. 9 - Maximum Safe Operating Area

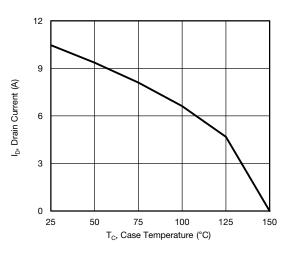


Fig. 10 - Maximum Drain Current vs. Case Temperature

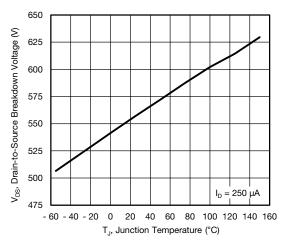
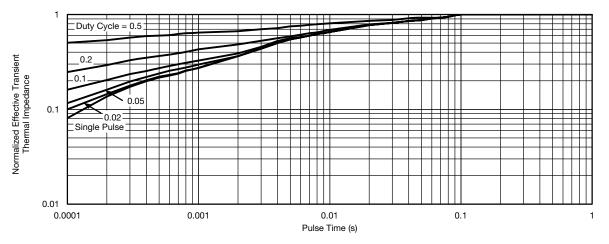


Fig. 11 - Temperature vs. Drain-to-Source Voltage

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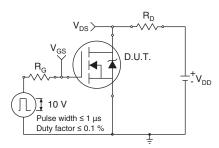


Fig. 13 - Switching Time Test Circuit

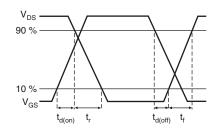


Fig. 14 - Switching Time Waveforms

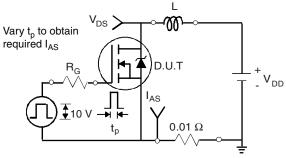


Fig. 15 - Unclamped Inductive Test Circuit

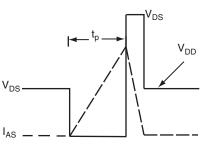


Fig. 16 - Unclamped Inductive Waveforms

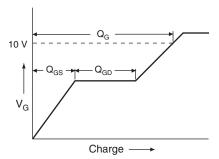
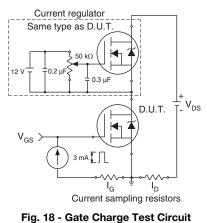


Fig. 17 - Basic Gate Charge Waveform



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Peak Diode Recovery dV/dt Test Circuit

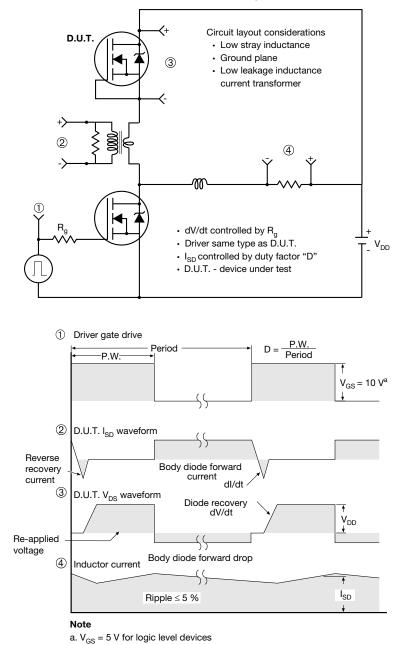


Fig. 19 - For N-Channel

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TO-220-1



DIM	MILLIN	METERS	INC	CHES
DIM.	MIN.	MAX.	MIN.	MAX.
А	4.24	4.65	0.167	0.183
b	0.69	1.02	0.027	0.040
b(1)	1.14	1.78	0.045	0.070
С	0.36	0.61	0.014	0.024
D	14.33	15.85	0.564	0.624
E	9.96	10.52	0.392	0.414
е	2.41	2.67	0.095	0.105
e(1)	4.88	5.28	0.192	0.208
F	1.14	1.40	0.045	0.055
H(1)	6.10	6.71	0.240	0.264
J(1)	2.41	2.92	0.095	0.115
L	13.36	14.40	0.526	0.567
L(1)	3.33	4.04	0.131	0.159
ØP	3.53	3.94	0.139	0.155
Q	2.54	3.00	0.100	0.118

Note

• M* = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM



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